

# MICRO-520 Laser microprocessing

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Cursus	Sem.	Type
Mechanical engineering	MA2, MA4	Opt.
Microtechnics	MA2, MA4	Opt.
Photonics minor	Е	Opt.

Language of teaching	English
Credits	2
Session	Summer
Semester	Spring
Exam	Oral
Workload	60h
Weeks	14
Hours	2 weekly
Courses	2 weekly
Number of positions	

# **Summary**

The physical principles of laser light materials interactions are introduced with a large number of industrial application examples. Materials processing lasers are developing further and further, the lecture presents the physical limitations of the processes.

#### Content

## 1. Basics of laser processing

Lasers for machining, Optics - beam steering systems, beam quality; Optical properties of materials, Heat equation, Applications - and examples:

Laser induced chemical reactions at surfaces for marking applications,

laser bending,

hole drilling,

laser cutting,

laser induced ablation,

gnerative processes

#### Keywords

laser, efficiency, beam quality, spot size, laser pulse duration, heat equation, losses, machining, marking, bending, drilling, cutting, ablation, generative processing, selective laser sintering, selective laser melting

# **Learning Outcomes**

By the end of the course, the student must be able to:

- Decide which laser to use for which task
- Interpret the result of a laser processed sample
- · Optimize a virtual laser process

# **Expected student activities**

participate actively in the lecture carry out exercises

## **Assessment methods**

Oral examination

## Resources

**Moodle Link** 

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**EPFL** 

• https://go.epfl.ch/MICRO-520

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